Device Modeling Report

COMPONENTS: OPERATIONAL AMPLIFIER (CMOS)

PART NUMBER: NJU7094

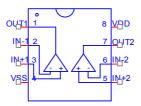
MANUFACTURER: NEW JAPAN RADIO



Bee Technologies Inc.

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Spice Model



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*PART NUMBER: NJU7094
*MANUFACTURER: NEW JAPAN RADIO
*CMOS OPAMP
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.SUBCKT nju7094 OUT1 IN-1 IN+1 VSS IN+2 IN-2 OUT2 VDD
X U1 IN+1 VSS IN-1 OUT1 VDD nju7094 s
X U2 IN+2 VSS IN-2 OUT2 VDD nju7094 s
.ENDS nju7094
.SUBCKT nju7094 s
                    IN+ VSS IN- OUT VDD
M1
           2 IN-3 VDD MbreakPD3
M2
           2 IN+ 4 VDD MbreakPD2
М3
           VDD 1 2 VDD MbreakPD
M4
           VDD 15 VDD MbreakPD
M5
           VDD 1 6 VDD MbreakPD
M6
           VDD 1 1 VDD MbreakPD
M7
           5 5 VSS VSS MbreakND W=3.2m
                                           L=6u
M8
           5 4 VSS VSS MbreakND3
M9
           3 3 IN1 VSS MbreakND1
M10
           4 3 IN2 VSS MbreakND1
M11
           1 6 11 11 MbreakND
                                W=9m
                                         L=6u
M12
           6 6 VSS VSS MbreakND3
M13
           7 5 VSS VSS MbreakND1
M14
           VDD 7 7 VDD MbreakPD
M15
           VDD 7 OUT VDD MbreakPD1
M16
           OUT 4 VSS VSS MbreakND2
C1
           OUT 15p
C2
          OUT IN-37p
C3
          OUT 3 1p
C4
          OUT 4 2p
R1
           11 VSS 1.522k
R2
          IN1 VSS 2.0k
R3
          IN2 VSS 2.423k
          0 IN- 0.505p
11
12
          0 IN+
                1.5p
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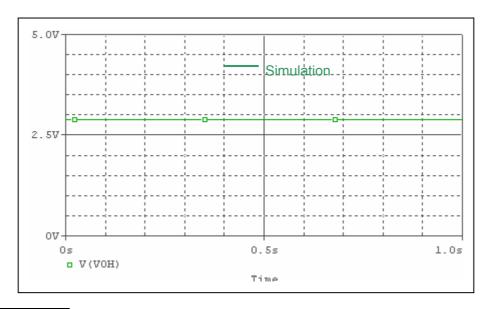
```
X U1
          VSS 3 DbreakZ
X U2
          VSS 4 DbreakZ
.model MbreakND NMOS (LEVEL=3 VTO=0.9 RS=10.000E-3 RD=10.000E-3
+ RDS=1.0000E6 TOX=2.0000E-6 CGSO=4.000E-12 CGDO=1.000E-12
+ CBD=1.000E-12 RG=5 RB=1.0000E-3 KP=10E-6)
.model MbreakND1 NMOS (LEVEL=3 L=6u W=0.5 VTO=1 RS=10.000E-3
+ RD=10.000E-3 RDS=1.0000E6 TOX=2.0000E-6 CGSO=1.00E-12
+ CGDO=1.000E-12 CBD=8.000E-11 RG=5 RB=1.0000E-3 KP=10E-6)
.model MbreakND2 NMOS (LEVEL=3 L=6u W=0.14m VTO=0.9
+ RS=10.000E-3 RD=10.000E-3 RDS=1.0000E6 TOX=2.0000E-6
+ CGSO=4.000E-12 CGDO=1.00E-12 CBD=1.000E-12 RG=5
+ RB=1.0000E-3 KP=10E-6)
.model MbreakND3 NMOS (LEVEL=3 L=6u W=3.2m VTO=0.9 RS=10.000E-3
+ RD=10.000E-3 RDS=1.0000E6 TOX=2.0000E-6 CGSO=1.000E-12
+ CGDO=1.000E-12 CBD=1.000E-12 RG=5 RB=1.0000E-3 KP=10E-6)
.model MbreakPD PMOS (LEVEL=3 L=6u W=0.023 VTO=-1 RS=10.000E-3
+ RD=10.000E-3 RDS=1.0000E6 TOX=2.0000E-6 CGSO=4.000E-12
+ CGDO=1.000E-12 CBD=1.000E-12 RG=5 RB=1.0000E-3 KP=1E-6)
.MODEL MbreakPD1 PMOS (LEVEL=3 L=6u W=0.00414 VTO=-0.9
+ RS=10.000E-3 RD=10.000E-3 RDS=1.00E6 TOX=2.0000E-6
+ CGSO=4.000E-12 CGDO=1.000E-12 CBD=1.000E-12 RG=5
+ RB=1.0000E-3 KP=1E-6)
.MODEL MbreakPD2 PMOS (LEVEL=3 L=6u W=0.0035 VTO=-1.5
+ RS=10.000E-3 RD=10.00E-3 RDS=1.075E6 TOX=2.0000E-6
+ CGSO=4.000E-12 CGDO=1.000E-12 CBD=1.00E-12 RG=5
+ RB=1.0000E-3 KP=1E-6)
.MODEL MbreakPD3 PMOS (LEVEL=3 L=6u W=0.0040865 VTO=-1.5
+ RS=10.000E-3 RD=10.00E-3 RDS=1.E6 TOX=2.0000E-6 CGSO=4.000E-12
+ CGDO=1.000E-12 CBD=1.00E-12 RG=5 RB=1.0000E-3 KP=1E-6)
.ENDS nju7094 s
.SUBCKT DbreakZ A K
D1 AK DF
DZ A2 A DR
VZKA21
.MODEL DF D
.MODEL DR D
.ENDS DbreakZ
*$
```

MOSFET MODEL

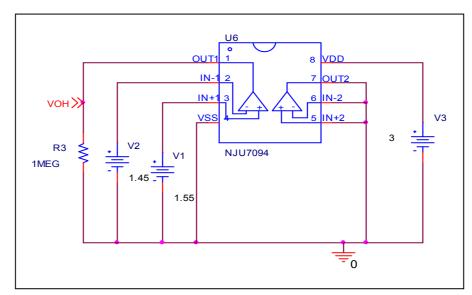
Pspice model	Model description
parameter	•
LEVEL	
L	Channel Length
W	Channel Width
KP	Transconductance
RS	Source Ohmic Resistance
RD	Ohmic Drain Resistance
VTO	Zero-bias Threshold Voltage
RDS	Drain-Source Shunt Resistance
TOX	Gate Oxide Thickness
CGSO	Zero-bias Gate-Source Capacitance
CGDO	Zero-bias Gate-Drain Capacitance
CBD	Zero-bias Bulk-Drain Junction Capacitance
MJ	Bulk Junction Grading Coefficient
PB	Bulk Junction Potential
FC	Bulk Junction Forward-bias Capacitance Coefficient
RG	Gate Ohmic Resistance
IS	Bulk Junction Saturation Current
N	Bulk Junction Emission Coefficient
RB	Bulk Series Resistance
PHI	Surface Inversion Potential
GAMMA	Body-effect Parameter
DELTA	Width effect on Threshold Voltage
ETA	Static Feedback on Threshold Voltage
THETA	Modility Modulation
KAPPA	Saturation Field Factor
VMAX	Maximum Drift Velocity of Carriers
XJ	Metallurgical Junction Depth
UO	Surface Mobility

Output Voltage Swing

Simulation result



Evaluation Circuit



VIN+ = (VDD/2) + 0.05, VIN- = (VDD/2) - 0.05

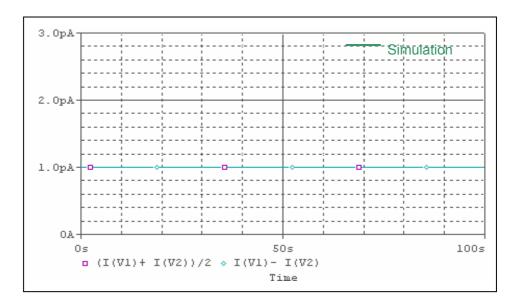
Comparison Table

	Measurement	Simulation	%Error
V _{OM} (V)	2.9	2.9	0

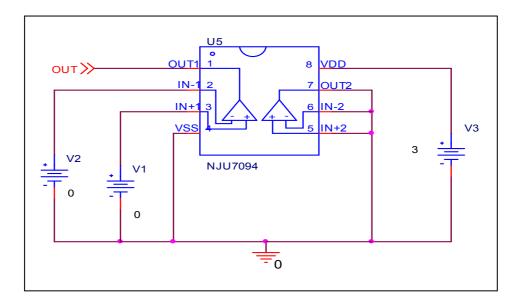
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Input Current

Simulation result



Evaluation Circuit

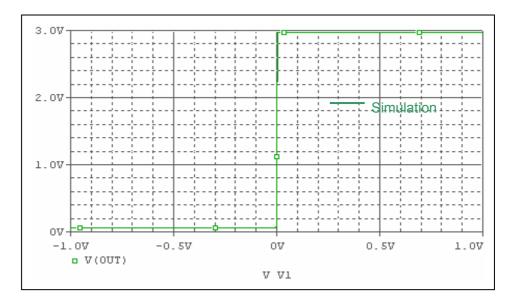


	Measurement	Simulation	% Error
I _b (pA)	1	1.002	0.2
I _{os} (pA)	1	0.995	-0.5

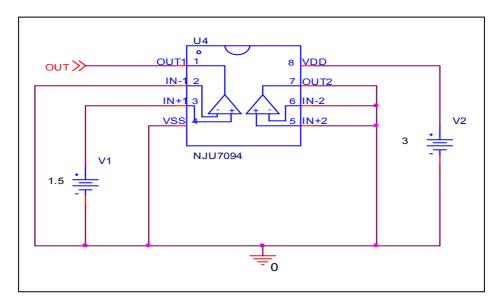
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Input Offset Voltage

Simulation result



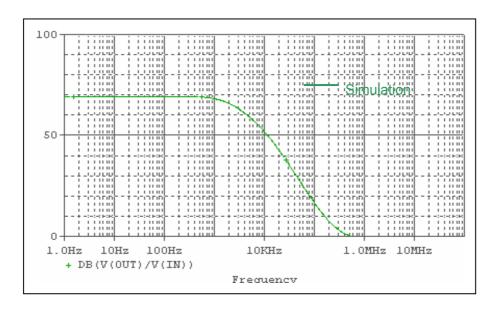
Evaluation Circuit



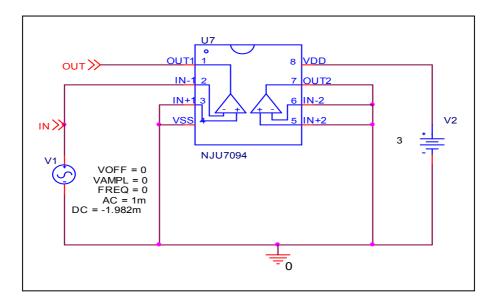
	Measurement	Simulation	%Error
V _{OS} (mV)	2	1.982	-0.9

Open loop Voltage Gain

Simulation result



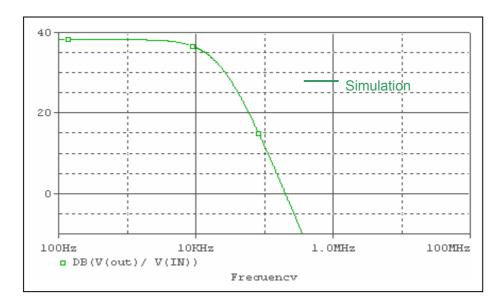
Evaluation Circuit



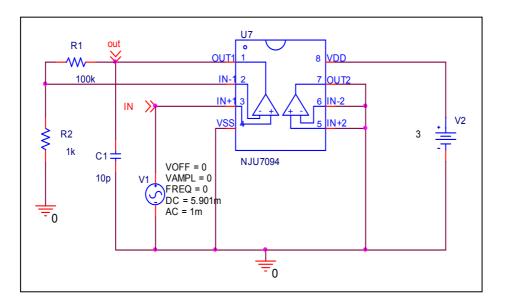
	Measurement	Simulation	%Error
Av (dB)	70	69.369	-0.901

Unity Gain Frequency

Simulation result



Evaluation Circuit



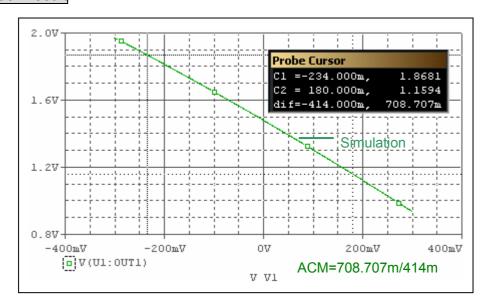
Comparison Table

A _V =40dB,C _L =10pF	Measurement	Simulation	%Error
Ft(MHz)	0.2	0.203	-1.5

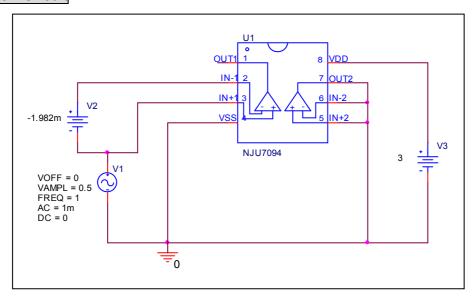
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Common-Mode Rejection Ratio

Simulation result



Evaluation Circuit

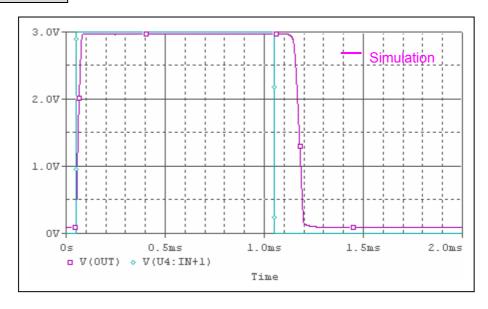


CMRR = AV/ACM

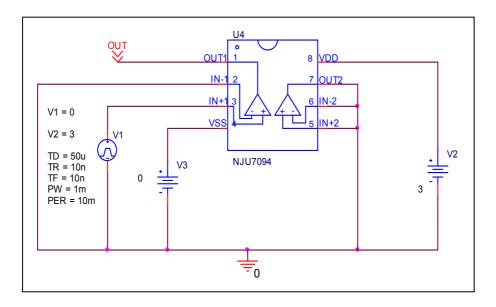
	Measurement	Simulation	%Error
CMRR (dB)	65	64.699	-0.463

Slew Rate

Simulation result



Evaluation Circuit



	Measurement	Simulation	% Error
SR (V/us)	0.1	0.102	2